



Automotive-grade N-channel 24 V, 0.95 mΩ typ., 180 A STripFET™ III Power MOSFET in a H²PAK-6 package

Datasheet - production data

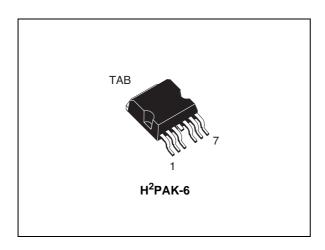
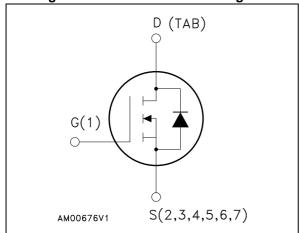


Figure 1. Internal schematic diagram



Features

Order code	V _{DSS}	R _{DS(on)} max.	I _D ⁽¹⁾
STH300NH02L-6	24 V	$<$ 1.2 m Ω	180 A

- 1. Current limited by package.
- Designed for automotive applications and AEC-Q101 qualified
- Conduction losses reduced
- Low profile, very low parasitic inductance, high current package

Applications

• Switching applications

Description

This device is an N-channel enhancement mode Power MOSFET produced using STMicroelectronics' STripFET™ III technology, which is specifically designed to minimize onresistance and gate charge to provide superior switching performance.

Table 1. Device summary

Order code	Order code Marking		Packaging
STH300NH02L-6	300NH02L	H ² PAK-6	Tape and reel

Contents STH300NH02L-6

Contents

1	Electrical ratings
2	Electrical characteristics4
	2.1 Electrical characteristics (curves)
3	Test circuits 8
4	Package mechanical data
5	Packaging mechanical data13
6	Revision history

STH300NH02L-6 Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{DS}	Drain-source voltage	24	V	
V _{GS}	Gate-source voltage	± 20	V	
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	180	Α	
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	180	Α	
I _{DM} ⁽²⁾	Drain current (pulsed)	720	Α	
P _{TOT} (3)	Total dissipation at T _C = 25 °C	300	W	
	Derating factor	2	W/°C	
E _{AS} (4)	Single pulse avalanche energy	1.6	J	
T _{stg}	Storage temperature	-55 to 175	°C	
T _j	Operating junction temperature	-55 to 175		

^{1.} Current limited by package

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	0.5	°C/W
R _{thj-pcb} (1)	Thermal resistance junction-pcb max	35	°C/W

^{1.} When mounted on 1 inch2 FR-4 2 oz Cu.

^{2.} Pulse width limited by safe operating area

^{3.} This value is rated according to $R_{\mbox{\scriptsize thj-c}}$

^{4.} Starting $T_j = 25$ °C, $I_D = 60$ A, $V_{DD} = 20$ V

Electrical characteristics STH300NH02L-6

2 Electrical characteristics

(Tcase = 25 °C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage (V _{GS} = 0)	I _D = 250 μA	24			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = 24 V, V _{DS} = 24 V, T _C =125 °C			1 10	μA μA
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			± 100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1			V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 80 A V _{GS} = 5 V, I _D = 40 A		0.95 1.15	1.2 1.5	mΩ

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	7050	-	pF
C _{oss}	Output capacitance	$V_{DS} = 15 \text{ V, f} = 1 \text{ MHz, V}_{GS} = 0$	-	3250	-	pF
C _{rss}	Reverse transfer capacitance		-	307	-	pF
Q _g	Total gate charge	V _{DD} = 20 V, I _D = 120 A,	-	109	-	nC
Q _{gs}	Gate-source charge	V _{GS} = 10 V	-	30	-	nC
Q _{gd}	Gate-drain charge	(see Figure 14)	-	26	-	nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 20 V, I _D = 80 A	-	18	-	ns
t _r	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$, (see Figure 13)	-	275	-	ns
t _{d(off)}	Turn-off delay time	V _{DD} = 20 V, I _D = 80 A	-	138	-	ns
t _f	Fall time	R_G = 4.7 Ω , V_{GS} = 10 V, (see Figure 13)	-	94.4	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD} ⁽¹⁾ I _{SD} ⁽²⁾	Source-drain current Source-drain current (pulsed)		-		180 720	A A
V _{SD} (3)	Forward on voltage	I _{SD} = 180 A, V _{GS} = 0	-		1.3	٧
t _{rr}	Reverse recovery time	I _{SD} = 120 A,di/dt = 100 A/μs	-	65		ns
Q _{rr}	Reverse recovery charg	V _{DD} = 20 V, T _j = 150 °C	-	90		пC
I _{RRM}	Reverse recovery current	(see Figure 15)	-	2.8		Α

- 1. Current limited by package
- 2. Pulse width limited by safe operating area
- 3. Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

Electrical characteristics STH300NH02L-6

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

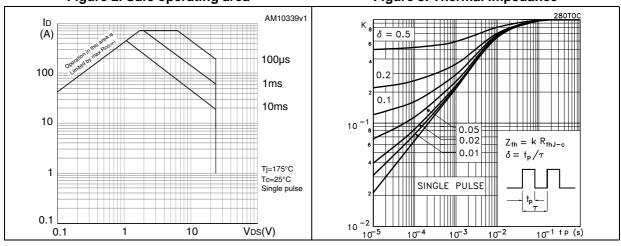


Figure 4. Output characteristics

Figure 5. Transfer characteristics

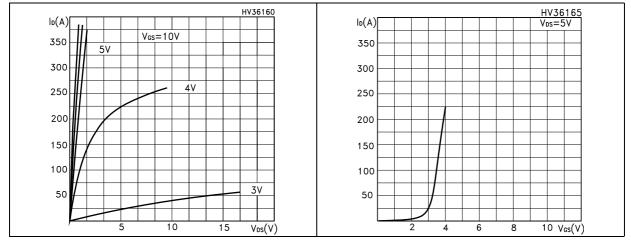


Figure 6. Normalized B_{VDSS} vs temperature

Figure 7. Static drain-source on-resistance

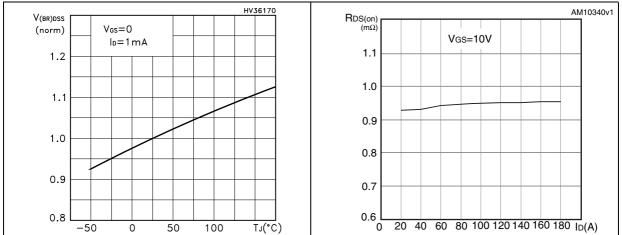


Figure 8. Gate charge vs gate-source voltage

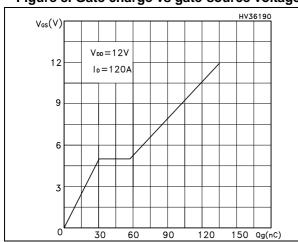


Figure 9. Capacitance variations

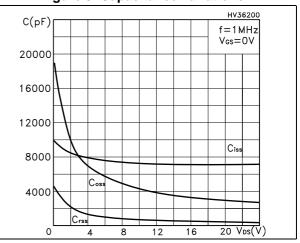
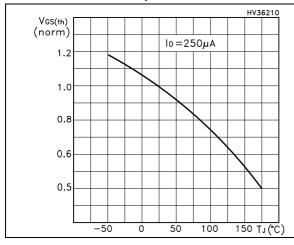


Figure 10. Normalized gate threshold voltage vs temperature

Figure 11. Normalized on resistance vs temperature



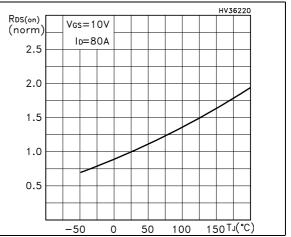
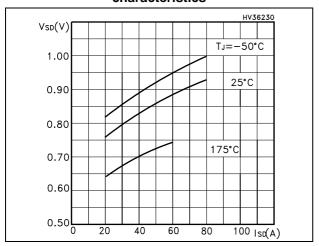


Figure 12. Source-drain diode forward characteristics



Test circuits STH300NH02L-6

3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

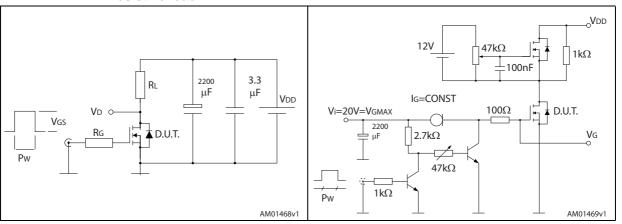


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

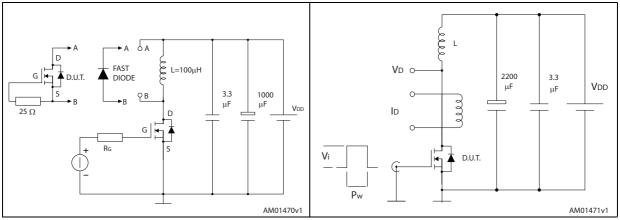
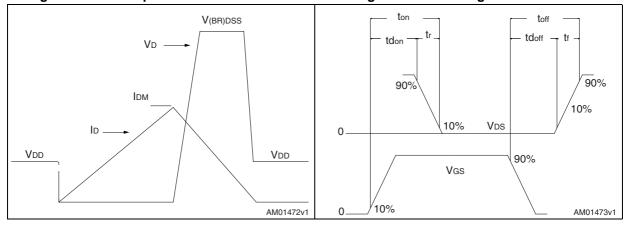


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 8. H²PAK-6 mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
Α	4.30		4.80
A1	0.03		0.20
С	1.17		1.37
е	2.34		2.74
e1	4.88		5.28
e2	7.42		7.82
Е	0.45		0.60
F	0.50		0.70
Н	10.00		10.40
H1	7.40	- 	7.80
L	14.75		15.25
L1	1.27		1.40
L2	4.35		4.95
L3	6.85		7.25
L4	1.5	1	1.75
М	1.90		2.50
R	0.20		0.60
V	0°		8°

Figure 19. H²PAK-6 drawing

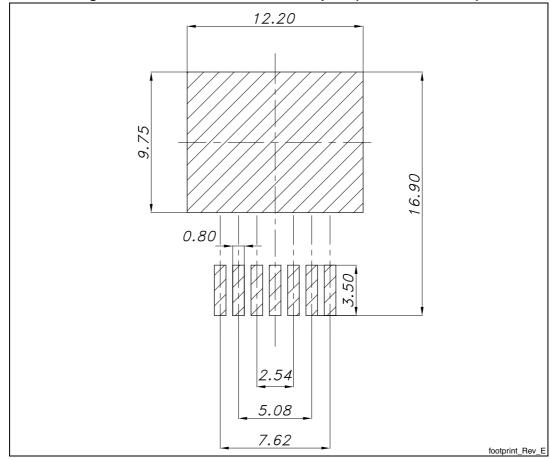


Figure 20. H²PAK-6 recommended footprint (dimensions in mm)

5 Packaging mechanical data

Table 9. Tape and reel mechanical data

	Таре			Reel	
		ım	Dim	m	nm
Dim.	Min.	Max.	Dim.	Min.	Max.
A0	10.5	10.7	Α		330
В0	15.7	15.9	В	1.5	
D	1.5	1.6	С	12.8	13.2
D1	1.59	1.61	D	20.2	
Е	1.65	1.85	G	24.4	26.4
F	11.4	11.6	N	100	
K0	4.8	5.0	Т		30.4
P0	3.9	4.1			
P1	11.9	12.1		Base qty	1000
P2	1.9	2.1		Bulk qty	1000
R	50				
Т	0.25	0.35			
W	23.7	24.3			

Figure 21. Tape

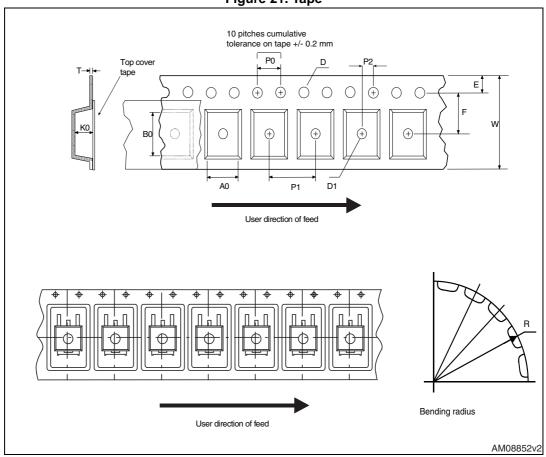
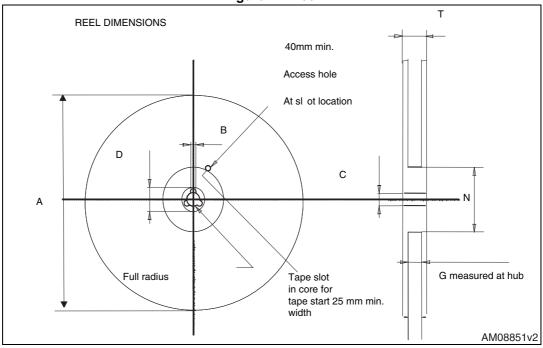


Figure 22. Reel



Revision history STH300NH02L-6

6 Revision history

Table 10. Document revision history

Date	Revision	Changes
12-Jul-2011	1	initial release
24-Oct-2011	2	Updated test conditions in Section Table 5.: Dynamic and Section Table 7.: Source drain diode.
15-May-2013	3	 Updated: title, Applications and Description in cover page Minor text changes
22-Jul-2013	4	- Updated title in cover page.

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